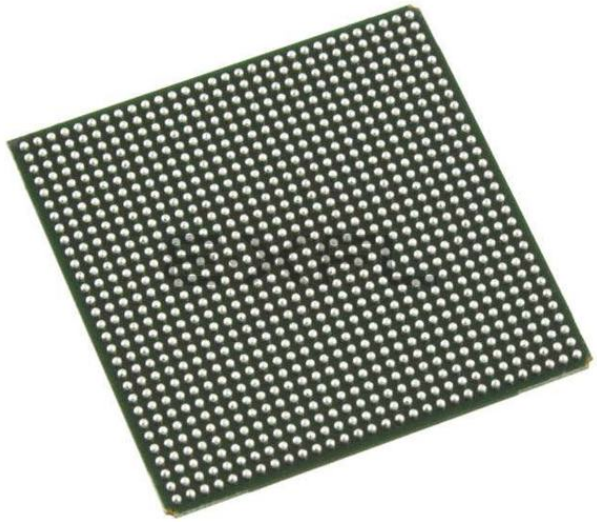

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	8375
Number of Logic Elements/Cells	67000
Total RAM Bits	4642816
Number of I/O	416
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m70e-6f900c

Modes of Operation

Each slice has up to four potential modes of operation: Logic, Ripple, RAM and ROM.

Logic Mode

In this mode, the LUTs in each slice are configured as 4-input combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any four input logic functions can be generated by programming this lookup table. Since there are two LUT4s per slice, a LUT5 can be constructed within one slice. Larger look-up tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other slices. Note LUT8 requires more than four slices.

Ripple Mode

Ripple mode supports the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each slice:

- Addition 2-bit
- Subtraction 2-bit
- Add/Subtract 2-bit using dynamic control
- Up counter 2-bit
- Down counter 2-bit
- Up/Down counter with Async clear
- Up/Down counter with preload (sync)
- Ripple mode multiplier building block
- Multiplier support
- Comparator functions of A and B inputs
  - A greater-than-or-equal-to B
  - A not-equal-to B
  - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, a 16x4-bit distributed single port RAM (SPR) can be constructed using each LUT block in Slice 0 and Slice 2 as a 16x1-bit memory. Slice 1 is used to provide memory address and control signals. A 16x2-bit pseudo dual port RAM (PDPR) memory is created by using one Slice as the read-write port and the other companion slice as the read-only port.

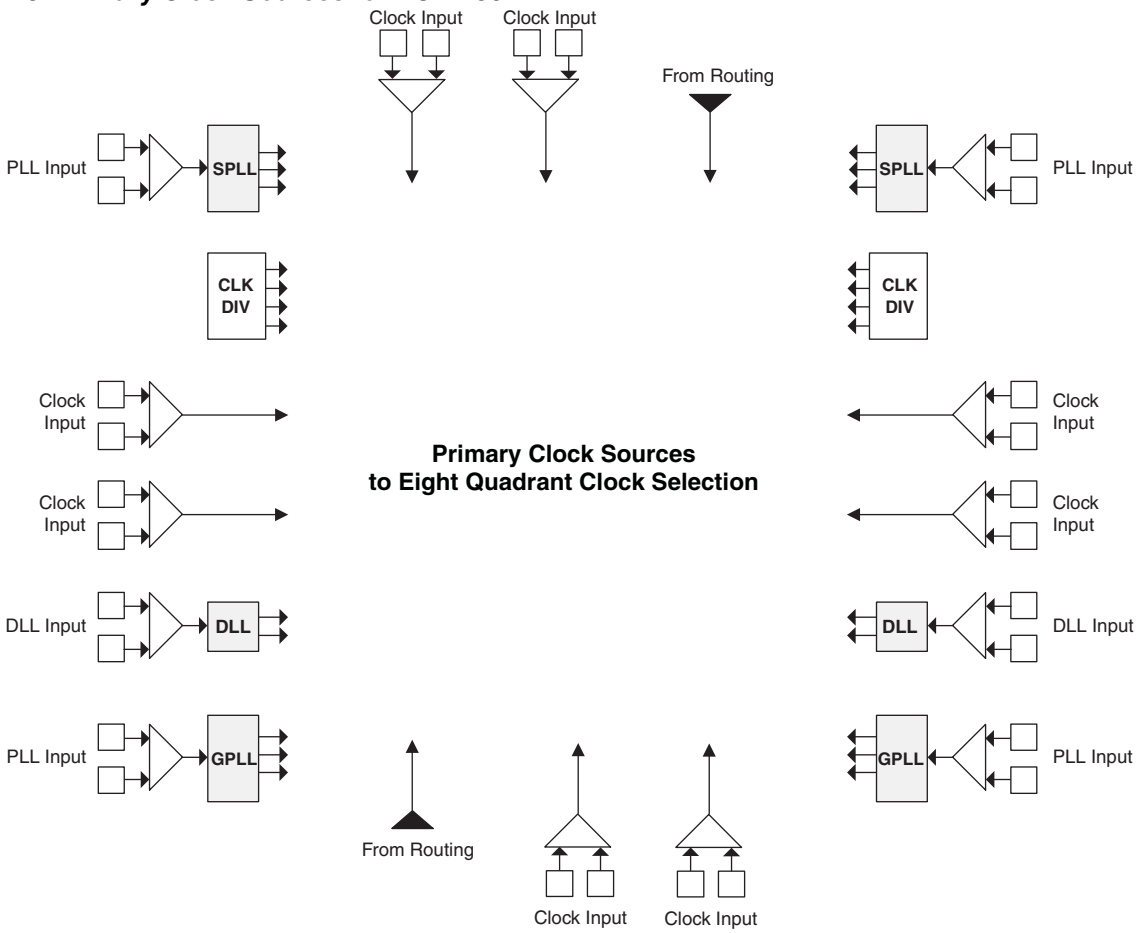
The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the PFU. Table 2-3 shows the number of slices required to implement different distributed RAM primitives. For more information about using RAM in LatticeECP2/M devices, please see the list of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required to Implement Distributed RAM

	SPR 16X4	PDPR 16X4
Number of slices	3	3

Note: SPR = Single Port RAM, PDPR = Pseudo Dual Port RAM

Figure 2-10. Primary Clock Sources for ECP2-50

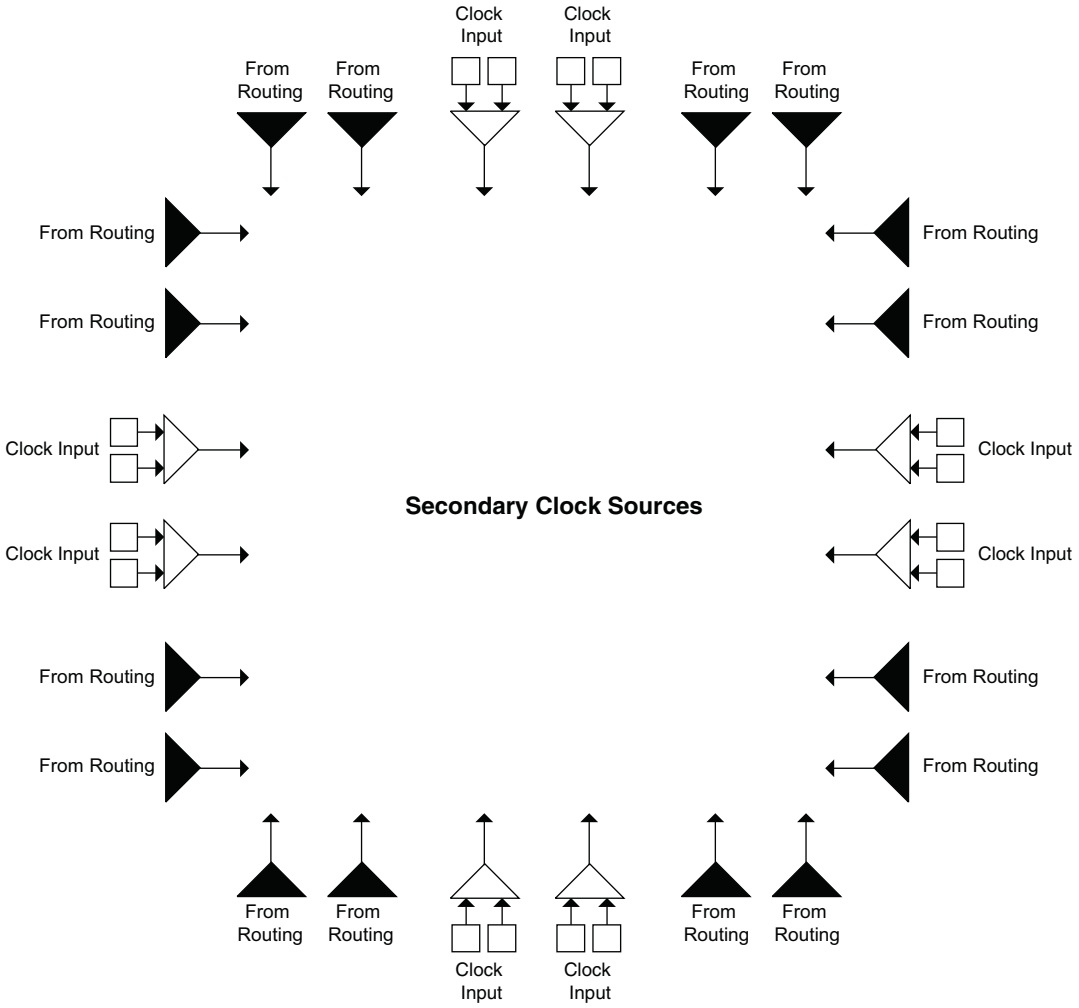


Note: This diagram shows sources for the ECP2-50 device. Smaller LatticeECP2 devices have fewer SPLLs. All LatticeECP2M devices have six SPLLs.

Secondary Clock/Control Sources

LatticeECP2/M devices derive secondary clocks (SC0 through SC7) from eight dedicated clock input pads and the rest from routing. Figure 2-11 shows the secondary clock sources.

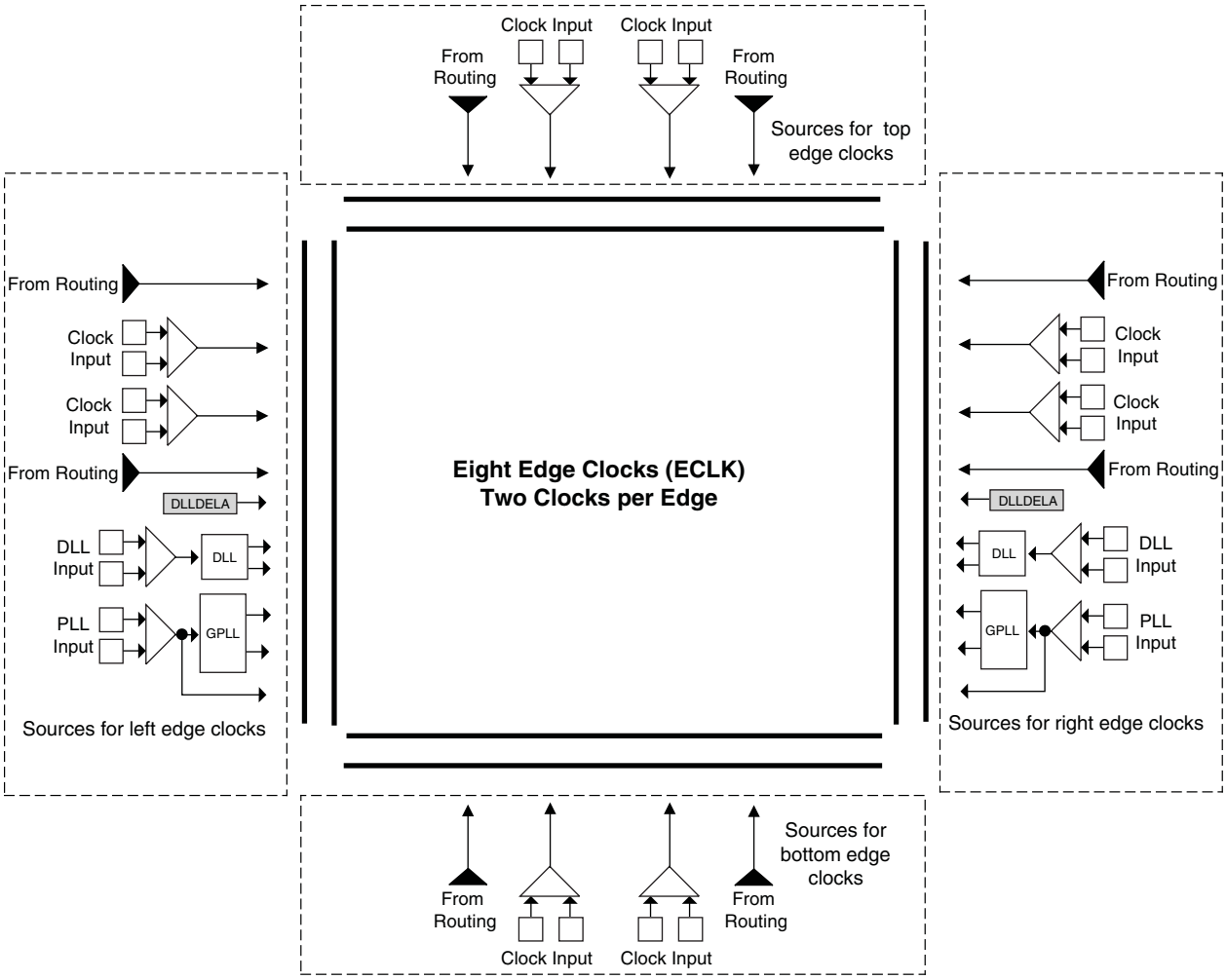
Figure 2-11. Secondary Clock Sources



Edge Clock Sources

Edge clock resources can be driven from a variety of sources at the same edge. Edge clock resources can be driven from adjacent edge clock PIOs, primary clock PIOs, PLLs/DLLs and clock dividers as shown in Figure 2-12.

Figure 2-12. Edge Clock Sources



sysI/O Recommended Operating Conditions

Standard	V_{CCIO}			V_{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVCMOS 3.3[2]	3.135	3.3	3.465	—	—	—
LVCMOS 2.5[2]	2.375	2.5	2.625	—	—	—
LVCMOS 1.8	1.71	1.8	1.89	—	—	—
LVCMOS 1.5	1.425	1.5	1.575	—	—	—
LVCMOS 1.2[2]	1.14	1.2	1.26	—	—	—
LVTTL[2]	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18[2] Class I, II	1.71	1.8	1.89	0.833	0.9	0.969
SSTL2[2] Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3[2] Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL[2] 15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL[2] 18 Class I, II	1.71	1.8	1.89	0.816	0.9	1.08
LVDS[2]	2.375	2.5	2.625	—	—	—
MLVDS25[1]	2.375	2.5	2.625	—	—	—
LVPECL33[1, 2]	3.135	3.3	3.465	—	—	—
BLVDS25[1, 2]	2.375	2.5	2.625	—	—	—
RSDS[1, 2]	2.375	2.5	2.625	—	—	—
SSTL18D_I[2], II[2]	1.71	1.8	1.89	—	—	—
SSTL25D_ I[2], II[2]	2.375	2.5	2.625	—	—	—
SSTL33D_ I[2], II[2]	3.135	3.3	3.465	—	—	—
HSTL15D_ I[2]	1.425	1.5	1.575	—	—	—
HSTL18D_ I[2], II[2]	1.71	1.8	1.89	—	—	—

1. Inputs on chip. Outputs are implemented with the addition of external resistors.
2. Input on this standard does not depend on the value of V_{CCIO}.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}[1] (mA)	I_{OH}[1] (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	V_{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2.0	3.6	0.4	V_{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	V_{CCIO} - 0.4	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.8	-0.3	0.35 V_{CCIO}	0.65 V_{CCIO}	3.6	0.4	V_{CCIO} - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.5	-0.3	0.35 V_{CCIO}	0.65 V_{CCIO}	3.6	0.4	V_{CCIO} - 0.4	8, 4	-8, -4
					0.2	V_{CCIO} - 0.2	0.1	-0.1
LVCMOS 1.2	-0.3	0.35 V_{CC}	0.65 V_{CC}	3.6	0.4	V_{CCIO} - 0.4	6, 2	-6, -2
					0.2	V_{CCIO} - 0.2	0.1	-0.1
PCI	-0.3	0.3 V_{CCIO}	0.5 V_{CCIO}	3.6	0.1 V_{CCIO}	0.9 V_{CCIO}	1.5	-0.5
SSTL3 Class I	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.7	V_{CCIO} - 1.1	8	-8
SSTL3 Class II	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.5	V_{CCIO} - 0.9	16	-16
SSTL2 Class I	-0.3	V_{REF} - 0.18	V_{REF} + 0.18	3.6	0.54	V_{CCIO} - 0.62	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3	V_{REF} - 0.18	V_{REF} + 0.18	3.6	0.35	V_{CCIO} - 0.43	15.2	-15.2
							20	-20
SSTL18 Class I	-0.3	V_{REF} - 0.125	V_{REF} + 0.125	3.6	0.4	V_{CCIO} - 0.4	6.7	-6.7
SSTL18 Class II	-0.3	V_{REF} - 0.125	V_{REF} + 0.125	3.6	0.28	V_{CCIO} - 0.28	8	-8
							11	-11
HSTL Class I	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCIO} - 0.4	4	-4
							8	-8
HSTL18 Class I	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCIO} - 0.4	8	-8
							12	-12
HSTL18 Class II	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCIO} - 0.4	16	-16

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed n * 8mA, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
		LFE2M100	1.00	—	1.20	—	1.40	—	ns
t_{SU_DELPLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
		LFE2M100	2.00	—	2.20	—	2.40	—	ns
t_{H_DELPLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
DDR I/O Pin Parameters[2]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR}	DDR Clock Frequency[6]	ECP2/M	95	200	95	166	95	133	MHz
DDR2 I/O Pin Parameters[3]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

sysCLOCK GPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	20	—	420	MHz
		With external capacitor[5]	5	—	50	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.156	—	210	MHz
		With external capacitor[5]	0.039	—	25	MHz
f_{VCO}	PLL VCO Frequency		640	—	1280	MHz
f_{PFD}	Phase Detector Input Frequency	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	50	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected[3]	45	50	55	%
t_{PH}[4]	Output Phase Accuracy		—	—	±0.05	UI
t_{OPJIT}[1]	Output Clock Period Jitter	$f_{OUT} \geq 100$ MHz	—	—	±125	ps
		$50 \leq f_{OUT} < 100$ MHz	—		0.025	UIPP
		$f_{OUT} < 50$ MHz	—	—	0.04	UIPP
t_{SK}	Input Clock to Output Clock Skew	N/M = integer	—	—	±250	ps
t_W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t_{LOCK}[2]	PLL Lock-in Time	Without external capacitor	—	—	150	µs
		With external capacitor[5]	—	—	500	µs
t_{PA}	Programmable Delay Unit		85	130	360	ps
t_{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width (RESETM/RESETK)		15	—	—	ns
	Reset Signal Pulse Width (CNTRST)	Without external capacitor	500	—	—	ns
		With external capacitor[5]	20	—	—	µs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Relative to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

LatticeECP2 Power Supply and NC

Signals	144 TQFP[3]	208 PQFP[3]	256 fpBGA[4]	484 fpBGA[4]
VCC	16, 22, 29, 48, 54, 83, 94, 102, 128, 135	12, 19, 28, 40, 74, 80, 97, 116, 129, 140, 146, 171, 188, 198	**LFE2-6:** G7, G9, G10, H7, J10, K10, K8 **LFE2-12/LFE2-20:** G7, G9, G10, H7, J10, K10, K8	**LFE2-12/LFE2-20:** N6, N18, J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 **LFE2-35/LFE2-50:** J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13
VCCIO0	139	195, 206	C5, E7	G10, G9, H8, H9
VCCIO1	117	162, 170	C12, E10	G11, G12, G13, G14
VCCIO2	106	143, 148	E14, G12	H14, H15, J15, K16
VCCIO3	89	123, 135	K12, M14	L16, M16, N16, P16
VCCIO4	64	93, 100	M10, P12	R14, T12, T13, T14
VCCIO5	42	55, 63	M7, P5	R9, T10, T11, T9
VCCIO6	31	38, 44	K5, M3	N7, P7, P8, R8
VCCIO7	9	10, 14	E3, G5	J8, K7, L7, M7
VCCIO8	85	113, 118	T15	P15, R15
VCCJ	35	51	K7	T8
VCCAUX	6, 39, 90, 142	7, 30, 70, 86, 125, 151, 174, 190	G8, H10, J7, K9	G5, K5, R5, V7, V11, V8, V13, V15, M17, P17, E17, G18, D11, F13, C5, E6
VCCPLL	None	None	None	**LFE2-12/LFE2-20:** None **LFE2-35:** N6, N18 **LFE2-50:** N6, N18, K6, J16
GND[1]	11, 21, 30, 47, 51, 61, 81, 95, 105, 120, 133, 138	5, 13, 17, 25, 32, 42, 60, 68, 77, 81, 89, 102, 115, 122, 139, 145, 159, 169, 175, 184, 192, 201	A1, A16, B12, B5, C8, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16	A22, AA19, AA4, AB1, AB22, B19, B4, C14, C9, D2, D21, F17, F6, H10, H11, H12, H13, J14, J20, J3, J9, K10, K11, K12, K13, K15, K8, L10, L11, L12, L13, L15, L8, M10, M11, M12, M13, M15, M8, N10, N11, N12, N13, N15, N8, P14, P20, P3, P9, R10, R11, R12, R13, U17, U6, W2, W21, Y14, Y9, A1
NC[2]	**LFE2-6:** 45, 46, 124, 127 **LFE2-12:** 127	None	**LFE2-6:** K6, R3, P4 **LFE2-12/LFE2-20:** None	**LFE2-12:** E3, F3, F1, H4, F2, H5, G1, G3, G2, G4, K6, N1, M2, N2, M1, N3, N5, N4, P5, N19, M19, J22, L22, H22, K22, J16, D22, F21, E21, E22, H19, G20, G19, F20, C21, C22, H6, J6, H3, H2, H17, H16, H20, H18 **LFE2-20/LFE2-35:** K6, J16, H6, J6, H3, H2, H17, H16, H20, H18 **LFE2-50:** None

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. Pin orientation follows the conventional order from the pin 1 marking of the top side view and counter-clockwise.
4. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*
47	PL30A	6	LDQ28		PL44A	6	LDQ42	
48	TCK	-			TCK	-		
49	TDI	-			TDI	-		
50	TDO	-			TDO	-		
51	VCCJ	-			VCCJ	-		
52	TMS	-			TMS	-		
53	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
54	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
55	VCCIO5	5			VCCIO5	5		
56	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
57	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
58	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
59	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
60	GND	-			GND	-		
61	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T
62	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C
63	VCCIO5	5			VCCIO5	5		
64	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T
65	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C
66	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T
67	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C
68	GND	-			GND	-		
69	PB20A	5	BDQ24	T	PB30A	5	BDQ33	T
70	VCCAUX	-			VCCAUX	-		
71	PB20B	5	BDQ24	C	PB30B	5	BDQ33	C
72	PB22A	5	BDQ24	T	PB32A	5	BDQ33	T
73	PB22B	5	BDQ24	C	PB32B	5	BDQ33	C
74	VCC	-			VCC	-		
75	PB26A	5	PCLKT5_0/BDQ24	T	PB35A	5	PCLKT5_0/BDQ33	T
76	PB26B	5	PCLKC5_0/BDQ24	C	PB35B	5	PCLKC5_0/BDQ33	C
77	GND	-			GND	-		
78	PB31A	4	PCLKT4_0/BDQ33	T	PB40A	4	PCLKT4_0/BDQ42	T
79	PB31B	4	PCLKC4_0/BDQ33	C	PB40B	4	PCLKC4_0/BDQ42	C
80	VCC	-			VCC	-		
81	GND	-			GND	-		
82	PB34A	4	BDQ33	T	PB42A	4	BDQS42	T
83	PB34B	4	BDQ33	C	PB42B	4	BDQ42	C
84	PB36A	4	BDQ33	T	PB44A	4	BDQ42	T
85	PB36B	4	BDQ33	C	PB44B	4	BDQ42	C
86	VCCAUX	-			VCCAUX	-		
87	PB40A	4	BDQ42	T	PB50A	4	BDQ51	T
88	PB40B	4	BDQ42	C	PB50B	4	BDQ51	C
89	GND	-			GND	-		
90	PB42A	4	BDQS42	T	PB52A	4	BDQ51	T
91	PB42B	4	BDQ42	C	PB52B	4	BDQ51	C

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M8	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
P7	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
R8	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
VCCIO	VCCIO4	4			VCCIO4	4		
T5	PB14A	4	BDQ15	T	PB32A	4	BDQ33	T
T6	PB14B	4	BDQ15	C	PB32B	4	BDQ33	C
T8	PB15A	4	BDQS15	T	PB33A	4	BDQS33	T
GND	GNDIO4	-			GNDIO4	-		
R7	PB16A	4	BDQ15	T	PB34A	4	BDQ33	T
T9	PB15B	4	BDQ15	C	PB33B	4	BDQ33	C
T7	PB16B	4	BDQ15	C	PB34B	4	BDQ33	C
L8	PB17A	4	BDQ15	T	PB35A	4	BDQ33	T
VCCIO	VCCIO4	4			VCCIO4	4		
P8	PB18A	4	BDQ15	T	PB36A	4	BDQ33	T
L9	PB17B	4	BDQ15	C	PB35B	4	BDQ33	C
N8	PB18B	4	BDQ15	C	PB36B	4	BDQ33	C
R9	PB19A	4	BDQ15	T	PB37A	4	BDQ33	T
GND	GNDIO4	-			GNDIO4	-		
R10	PB19B	4	BDQ15	C	PB37B	4	BDQ33	C
-	-	-			VCCIO	4		
-	-	-			GNDIO4	4		
N9	PB20A	4	BDQ24	T	PB47A	4	BDQ51	T
T10	PB21A	4	BDQ24	T	PB48A	4	BDQ51	T
M9	PB20B	4	BDQ24	C	PB47B	4	BDQ51	C
R11	PB21B	4	BDQ24	C	PB48B	4	BDQ51	C
P10	PB22A	4	BDQ24	T	PB49A	4	BDQ51	T
N11	PB23A	4	BDQ24	T	PB50A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
N10	PB22B	4	BDQ24	C	PB49B	4	BDQ51	C
P11	PB23B	4	BDQ24	C	PB50B	4	BDQ51	C
T11	PB24A	4	BDQS24	T	PB51A	4	BDQS51	T
GND	GNDIO4	-			GNDIO4	-		
M11	PB25A	4	BDQ24	T	PB52A	4	BDQ51	T
T12	PB24B	4	BDQ24	C	PB51B	4	BDQ51	C
L11	PB25B	4	BDQ24	C	PB52B	4	BDQ51	C
T13	PB26A	4	BDQ24	T	PB53A	4	BDQ51	T
R13	PB27A	4	BDQ24	T	PB54A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
T14	PB26B	4	BDQ24	C	PB53B	4	BDQ51	C
P13	PB27B	4	BDQ24	C	PB54B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
N12	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
M12	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
R15	CFG2	8			CFG2	8		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W5	PL38B	6	LDQ42	C (LVDS)*	PL52B	6	LDQ56	C (LVDS)*
AC1	PL39A	6	LDQ42	T	PL53A	6	LDQ56	T
AD1	PL39B	6	LDQ42	C	PL53B	6	LDQ56	C
VCCIO	VCCIO6	6			VCCIO6	6		
Y6	PL40A	6	LDQ42	T (LVDS)*	PL54A	6	LDQ56	T (LVDS)*
Y5	PL40B	6	LDQ42	C (LVDS)*	PL54B	6	LDQ56	C (LVDS)*
AE2	PL41A	6	LDQ42	T	PL55A	6	LDQ56	T
AD2	PL41B	6	LDQ42	C	PL55B	6	LDQ56	C
GND	GNDIO6	-			GNDIO6	-		
AB3	PL42A	6	LDQS42	T (LVDS)*	PL56A	6	LDQS56	T (LVDS)*
AB2	PL42B	6	LDQ42	C (LVDS)*	PL56B	6	LDQ56	C (LVDS)*
W7	PL43A	6	LDQ42	T	PL57A	6	LDQ56	T
VCCIO	VCCIO6	6			VCCIO6	6		
W8	PL43B	6	LDQ42	C	PL57B	6	LDQ56	C
Y7	PL44A	6	LDQ42	T (LVDS)*	PL58A	6	LDQ56	T (LVDS)*
Y8	PL44B	6	LDQ42	C (LVDS)*	PL58B	6	LDQ56	C (LVDS)*
AC2	PL45A	6	LDQ42	T	PL59A	6	LDQ56	T
GND	GNDIO6	-			GNDIO6	-		
AD3	PL45B	6	LDQ42	C	PL59B	6	LDQ56	C
AC3	TCK	-			TCK	-		
AA8	TDI	-			TDI	-		
AB4	TMS	-			TMS	-		
AA5	TDO	-			TDO	-		
AB5	VCCJ	-			VCCJ	-		
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GND	GNDIO5	-			GNDIO5	-		
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
K28	PR25A	2	RDQ29	T (LVDS)*
J24	PR24B	2	RDQ21	C
J26	PR24A	2	RDQ21	T
GND	GNDIO2	-		
K29	PR23B	2	RDQ21	C (LVDS)*
K30	PR23A	2	RDQ21	T (LVDS)*
J23	PR22B	2	RDQ21	C
J25	PR22A	2	RDQ21	T
VCCIO	VCCIO2	99		
J27	PR21B	2	RDQ21	C (LVDS)*
J28	PR21A	2	RDQS21	T (LVDS)*
H26	PR20B	2	RDQ21	C
GND	GNDIO2	-		
H24	PR20A	2	RDQ21	T
J29	PR19B	2	RDQ21	C (LVDS)*
J30	PR19A	2	RDQ21	T (LVDS)*
H25	PR18B	2	RDQ21	C
VCCIO	VCCIO2	2		
H23	PR18A	2	RDQ21	T
G27	PR15B	2	RUM1_SPLLC_FB_A/RDQ12	C
GND	GNDIO2	-		
H27	PR15A	2	RUM1_SPLLT_FB_A/RDQ12	T
G29	PR14B	2	RUM1_SPLLC_IN_A/RDQ12	C (LVDS)*
G28	PR14A	2	RUM1_SPLLT_IN_A/RDQ12	T (LVDS)*
VCCIO	VCCIO2	2		
GND	GNDIO2	-		
G26	PR6B	2		C (LVDS)*
G25	PR6A	2		T (LVDS)*
G30	PR5B	2		C
F30	PR5A	2		T
VCCIO	VCCIO2	2		
F26	PR4B	2		C (LVDS)*
F27	PR4A	2		T (LVDS)*
F29	PR3B	2		C
GND	GNDIO2	-		
F28	PR3A	2		T
H29	PR2B	2	VREF2_2	C (LVDS)*
H30	PR2A	2	VREF1_2	T (LVDS)*
VCCIO	VCCIO2	2		
B26	PT100B	1	VREF2_1	C
A26	PT100A	1	VREF1_1	T
GND	GNDIO1	-		
C25	PT99B	1		C

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
E21	PT76A	1		T
VCCIO	VCCIO1	1		
B22	PT75B	1		C
A22	PT75A	1		T
H20	PT74B	1		C
F21	PT74A	1		T
F20	PT73B	1		C
GND	GNDIO1	-		
H19	PT73A	1		T
D21	PT72B	1		C
C21	PT72A	1		T
E20	PT71B	1		C
VCCIO	VCCIO1	1		
G21	PT71A	1		T
B21	PT70B	1		C
A21	PT70A	1		T
F19	PT69B	1		C
G20	PT69A	1		T
E19	PT68B	1		C
GND	GNDIO1	-		
G19	PT68A	1		T
D20	PT67B	1		C
VCCIO	VCCIO1	1		
C20	PT67A	1		T
B20	PT66B	1		C
A20	PT66A	1		T
F18	PT65B	1		C
H18	PT65A	1		T
D19	PT64B	1		C
C19	PT64A	1		T
GND	GNDIO1	-		
G18	PT63B	1		C
E18	PT63A	1		T
H17	PT62B	1		C
F17	PT62A	1		T
VCCIO	VCCIO1	1		
G17	PT61B	1		C
E17	PT61A	1		T
B19	PT60B	1		C
A19	PT60A	1		T
GND	GNDIO1	-		
D17	PT59B	1		C
B18	PT59A	1		T

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V12	VCCAUX	-			VCCAUX	-		
V15	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
A13	GND	-			GND	-		
A19	GND	-			GND	-		
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA2	GND	-			GND	-		
AA25	GND	-			GND	-		
AB18	GND	-			GND	-		
AB22	GND	-			GND	-		
AB5	GND	-			GND	-		
AB9	GND	-			GND	-		
AE1	GND	-			GND	-		
AE11	GND	-			GND	-		
AE16	GND	-			GND	-		
AE22	GND	-			GND	-		
AE26	GND	-			GND	-		
AE6	GND	-			GND	-		
AF13	GND	-			GND	-		
AF19	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B11	GND	-			GND	-		
B16	GND	-			GND	-		
B22	GND	-			GND	-		
B26	GND	-			GND	-		
B6	GND	-			GND	-		
E18	GND	-			GND	-		
E22	GND	-			GND	-		
E5	GND	-			GND	-		
E9	GND	-			GND	-		
F2	GND	-			GND	-		
F25	GND	-			GND	-		
G11	GND	-			GND	-		
G16	GND	-			GND	-		
J22	GND	-			GND	-		
J5	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K3	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M7	VCCIO7	7			VCCIO7	7		
N10	VCCIO7	7			VCCIO7	7		
N3	VCCIO7	7			VCCIO7	7		
P10	VCCIO7	7			VCCIO7	7		
R6	VCCIO7	7			VCCIO7	7		
AA25	VCCIO8	8			VCCIO8	8		
AD28	VCCIO8	8			VCCIO8	8		
AA10	VCCAUX	-			VCCAUX	-		
AA11	VCCAUX	-			VCCAUX	-		
AA20	VCCAUX	-			VCCAUX	-		
AA21	VCCAUX	-			VCCAUX	-		
K10	VCCAUX	-			VCCAUX	-		
K11	VCCAUX	-			VCCAUX	-		
K20	VCCAUX	-			VCCAUX	-		
K21	VCCAUX	-			VCCAUX	-		
L10	VCCAUX	-			VCCAUX	-		
L11	VCCAUX	-			VCCAUX	-		
L20	VCCAUX	-			VCCAUX	-		
L21	VCCAUX	-			VCCAUX	-		
Y10	VCCAUX	-			VCCAUX	-		
Y11	VCCAUX	-			VCCAUX	-		
Y20	VCCAUX	-			VCCAUX	-		
Y21	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A13	GND	-			GND	-		
A18	GND	-			GND	-		
A24	GND	-			GND	-		
A30	GND	-			GND	-		
A7	GND	-			GND	-		
AA14	GND	-			GND	-		
AA15	GND	-			GND	-		
AA16	GND	-			GND	-		
AA17	GND	-			GND	-		
AA24	GND	-			GND	-		
AA27	GND	-			GND	-		
AA4	GND	-			GND	-		
AB24	GND	-			GND	-		
AB7	GND	-			GND	-		
AD12	GND	-			GND	-		
AD19	GND	-			GND	-		
AD27	GND	-			GND	-		
AE22	GND	-			GND	-		
AE27	GND	-			GND	-		
AE4	GND	-			GND	-		
AE9	GND	-			GND	-		
AF14	GND	-			GND	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P16	GND	-			GND	-		
P17	GND	-			GND	-		
P18	GND	-			GND	-		
P20	GND	-			GND	-		
R10	GND	-			GND	-		
R11	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
R15	GND	-			GND	-		
R16	GND	-			GND	-		
R17	GND	-			GND	-		
R18	GND	-			GND	-		
R20	GND	-			GND	-		
R21	GND	-			GND	-		
R24	GND	-			GND	-		
R7	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T13	GND	-			GND	-		
T14	GND	-			GND	-		
T15	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T18	GND	-			GND	-		
T20	GND	-			GND	-		
T21	GND	-			GND	-		
T24	GND	-			GND	-		
T7	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U15	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
U18	GND	-			GND	-		
U20	GND	-			GND	-		
V14	GND	-			GND	-		
V15	GND	-			GND	-		
V16	GND	-			GND	-		
V17	GND	-			GND	-		
V27	GND	-			GND	-		
V4	GND	-			GND	-		
W23	GND	-			GND	-		
W8	GND	-			GND	-		
Y14	GND	-			GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W30	PR53A	3	RDQ55	T (LVDS)*	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
U27	PR52B	3	VREF2_3/RDQ55	C	PR60B	3	VREF2_3/RDQ63	C
V29	PR52A	3	VREF1_3/RDQ55	T	PR60A	3	VREF1_3/RDQ63	T
V31	PR51B	3	PCLKC3_0/RDQ55	C (LVDS)*	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
V32	PR51A	3	PCLKT3_0/RDQ55	T (LVDS)*	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
V33	PR49B	2	PCLKC2_0/RDQ46	C	PR57B	2	PCLKC2_0/RDQ54	C
V34	PR49A	2	PCLKT2_0/RDQ46	T	PR57A	2	PCLKT2_0/RDQ54	T
GNDIO	GNDIO2	-			GNDIO2	-		
U24	PR48B	2	RDQ46	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
U25	PR48A	2	RDQ46	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
V30	PR47B	2	RDQ46	C	PR55B	2	RDQ54	C
Y32	PR47A	2	RDQ46	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
U28	PR46B	2	RDQ46	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
U29	PR46A	2	RDQS46	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
U33	PR45B	2	RDQ46	C	PR53B	2	RDQ54	C
GNDIO	GNDIO2	-			GNDIO2	-		
U34	PR45A	2	RDQ46	T	PR53A	2	RDQ54	T
T30	PR44B	2	RDQ46	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
U30	PR44A	2	RDQ46	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
T29	PR43B	2	RUM3_SPLLC_FB_A/RDQ46	C	PR51B	2	RUM3_SPLLC_FB_A/RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
T28	PR43A	2	RUM3_SPLLT_FB_A/RDQ46	T	PR51A	2	RUM3_SPLLT_FB_A/RDQ54	T
U31	PR42B	2	RUM3_SPLLC_IN_A/RDQ46	C (LVDS)*	PR50B	2	RUM3_SPLLC_IN_A/RDQ54	C (LVDS)*
U32	PR42A	2	RUM3_SPLLT_IN_A/RDQ46	T (LVDS)*	PR50A	2	RUM3_SPLLT_IN_A/RDQ54	T (LVDS)*
T33	PR40B	2	RDQ37	C	PR48B	2	RDQ45	C
T34	PR40A	2	RDQ37	T	PR48A	2	RDQ45	T
GNDIO	GNDIO2	-			GNDIO2	-		
R27	PR39B	2	RDQ37	C (LVDS)*	PR47B	2	RDQ45	C (LVDS)*
R28	PR39A	2	RDQ37	T (LVDS)*	PR47A	2	RDQ45	T (LVDS)*
R29	PR38B	2	RDQ37	C	PR46B	2	RDQ45	C
R30	PR38A	2	RDQ37	T	PR46A	2	RDQ45	T
VCCIO	VCCIO2	2			VCCIO2	2		
R33	PR37B	2	RDQ37	C (LVDS)*	PR45B	2	RDQ45	C (LVDS)*
R34	PR37A	2	RDQS37	T (LVDS)*	PR45A	2	RDQS45	T (LVDS)*
R32	PR36B	2	RDQ37	C	PR44B	2	RDQ45	C
GNDIO	GNDIO2	-			GNDIO2	-		
R31	PR36A	2	RDQ37	T	PR44A	2	RDQ45	T
P34	PR35B	2	RDQ37	C (LVDS)*	PR43B	2	RDQ45	C (LVDS)*
P33	PR35A	2	RDQ37	T (LVDS)*	PR43A	2	RDQ45	T (LVDS)*
R26	PR34B	2	RDQ37	C	PR42B	2	RDQ45	C
VCCIO	VCCIO2	2			VCCIO2	2		
T25	PR34A	2	RDQ37	T	PR42A	2	RDQ45	T
P28	PR33B	2	RDQ37	C (LVDS)*	PR41B	2	RDQ45	C (LVDS)*
P27	PR33A	2	RDQ37	T (LVDS)*	PR41A	2	RDQ45	T (LVDS)*
P30	NC	-			PR40B	2		C
-	-	-			GNDIO2	-		
P29	NC	-			PR40A	2		T

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	20
LFE2-20E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	20
LFE2-20E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	20
LFE2-20E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	20
LFE2-20E-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	IND	20
LFE2-20E-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	IND	20
LFE2-20E-5FN672I	402	1.2V	-5	Lead-Free fpBGA	672	IND	20
LFE2-20E-6FN672I	402	1.2V	-6	Lead-Free fpBGA	672	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	IND	35
LFE2-35E-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	IND	35
LFE2-35E-5FN672I	450	1.2V	-5	Lead-Free fpBGA	672	IND	35
LFE2-35E-6FN672I	450	1.2V	-6	Lead-Free fpBGA	672	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484I	339	1.2V	-5	Lead-Free fpBGA	484	IND	50
LFE2-50E-6FN484I	339	1.2V	-6	Lead-Free fpBGA	484	IND	50
LFE2-50E-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	IND	50
LFE2-50E-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	IND	70
LFE2-70E-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	IND	70
LFE2-70E-5FN900I	583	1.2V	-5	Lead-Free fpBGA	900	IND	70
LFE2-70E-6FN900I	583	1.2V	-6	Lead-Free fpBGA	900	IND	70

LatticeECP2/M Family Data Sheet Revision History

September 2013 **Data Sheet DS1006**

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
August 2006	01.1	Introduction	
			Updated Table 1-1 “LatticeECP2 Family Selection Guide”.
		Architecture	Updated Figure 2-2 “PFU Diagram”.
			Updated Figure 2-13 “Secondary Clock Regions ECP2-50”.
			Updated Figure 2-25 “PIC Diagram”.
			Updated Figure 2-26 “Input Register Block for Left, Right and Bottom Edges”.
			Updated Figure 2-28 “Output Register Block for Left, Right and Bottom Edges”.
			Updated Figure 2-30 “DQS Input Routing for Left and Right Edges”.
			Updated Figure 2-32 “Edge Clock, DLL Calibration and DQS Local Bus Distribution”.
			Table 2-15 Selectable Master Clock (CCLK) Frequencies - Removed frequencies 15, 20, 21, 22, 23, 30, 34, 41, 45, 51, 55, 60.
			Replaced “CLKINDEL” with “CLKO”.
			Updated SED section.
			Qualified device migration capability when using DQS banks for DDR interfaces.
		DC and Switching Characteristics	Added VCCPLL to the Recommended Operating Conditions table.
			Removed note 5 from “Hot Specifications” section.
			Added notes 7 and 8 to “Initialization Supply” Current table.
			Change note 6 - “...down to 95MHz” to “...down to 95MHz for DDR and 133MHz for DDR2” .
			New “Typical Building Block Function Performance” numbers.
			New External Switching Characteristics numbers.
			New Internal Switching Characteristics numbers.
			New Family Timing Adders numbers.
			Updated Timings for GPLLs, SPLLs and DLLs.
			Added sysCONFIG waveforms.
			Remove HSTL15D_II from sysIO Recommended Operating Conditions table.
			Updated Supply and Initialization Currents for ECP2-50.
		Pinout Information	Added VCCPLL to the Signal Descriptions table.
			Updated Logic Signal Connections tables to include 484-fpBGA for the ECP2-50.
			Added Logic Signal Connections tables for ECP2-12 devices.
			Updated Pin Information Summary table to include ECP2-12.
			Updated Power Supply and NC Connections table to include ECP2-12.
			Added note 2 to DDR Strobe (DQS) Pin table.
			Added Information on: PCI, DDR & SPI4.2 Capabilities of the device-Package combination.